

L Number	Hits	Search Text	DB	Time stamp
1	0	photodiode near2 array and substrate and terminal and first near pad and second near pad and wire	USPAT; EPO; JPO; DERWENT	2004/08/25 16:27
2	2	photodiode near2 array and substrate and terminal and first near pad and second near pad and wire	USPAT; EPO; JPO; DERWENT	2004/08/25 16:38
3	9	photodiode and substrate and terminal and first near pad and second near pad and wire	USPAT; EPO; JPO; DERWENT	2004/08/25 16:39
4	7	(photodiode and substrate and terminal and first near pad and second near pad and wire) not (photodiode near2 array and substrate and terminal and first near pad and second near pad and wire)	USPAT; EPO; JPO; DERWENT	2004/08/25 16:39

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1	0	photodiode near2 array and substrate and terminal and first near pad and second near pad and wire	USPAT; EPO; JPO; DERWENT	2004/08/25 16:27
2	2	photodiode near2 array and substrate and terminal and first near pad and second near pad and wire	USPAT; EPO; JPO; DERWENT	2004/08/25 16:38
3	9	photodiode and substrate and terminal and first near pad and second near pad and wire	USPAT; EPO; JPO; DERWENT	2004/08/25 16:39
4	7	(photodiode and substrate and terminal and first near pad and second near pad and wire) not (photodiode near2 array and substrate and terminal and first near pad and second near pad and wire)	USPAT; EPO; JPO; DERWENT	2004/08/25 16:53
5	642	pad near5 (formation or protrusion) and wire and pad and substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 16:54
6	85	pad near5 (formation or protrusion) near5 section	USPAT; EPO; JPO; DERWENT	2004/08/25 16:54
8	0	(pad near5 (formation or protrusion) near5 section) and (photodiode and first adj pad and second adj pad)	USPAT; EPO; JPO; DERWENT	2004/08/25 16:55
7	15	photodiode and first adj pad and second adj pad	USPAT; EPO; JPO; DERWENT	2004/08/25 16:55

L Number	Hits	Search Text	DB	Time stamp
4	0	(mis and mid) adj substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 10:59
5	44	(mis or mid) adj substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 11:00
8	0	(mis adj substrate) and (mid adj substrate)	USPAT; EPO; JPO; DERWENT	2004/08/25 11:00
9	0	(mis adj substrate) and photo and light and pad and bond\$3 adj2 wir\$3	USPAT; EPO; JPO; DERWENT	2004/08/25 11:01
10	0	(mid adj substrate) and photo and light and pad and bond\$3 adj2 wir\$3	USPAT; EPO; JPO; DERWENT	2004/08/25 11:01
11	0	(mid adj substrate) and light and pad and bond\$3 adj2 wir\$3	USPAT; EPO; JPO; DERWENT	2004/08/25 11:02
13	0	(mis adj substrate) and light and pad and bond\$3 near2 wir\$3	USPAT; EPO; JPO; DERWENT	2004/08/25 11:02
12	1	(mid adj substrate) and light and pad and bond\$3 near2 wir\$3	USPAT; EPO; JPO; DERWENT	2004/08/25 11:02
6	6	mis adj substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 11:03
7	38	mid adj substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 11:03

L Number	Hits	Search Text	DB	Time stamp
1	1992	light adj emitting adj diode and pad\$1 and substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 17:25
2	0	phot adj diode and pad\$1 and substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 17:25
3	422	photo adj diode and pad\$1 and substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 17:25
4	422	(photo adj diode and pad\$1 and substrate) and substrate	USPAT; EPO; JPO; DERWENT	2004/08/25 17:25
5	18	(photo adj diode and pad\$1 and substrate) and substrate near5 (protrusion or recess)	USPAT; EPO; JPO; DERWENT	2004/08/25 17:26